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REV1
    DONE : Change 2N7002 to Si2303BDS .
    DONE : Exchange TP GND with TP2.
    DONE : add TP1 REF circuit .
    DONE : change PIC16F883 to PIC16F1824
    DONE : Don't Copper pour
DONE : Expand the aperture
    DONE : add 16F1824 +2_5VREF .
    DONE : change PIC16F1824 to C8051F350
   DONE : Add pressure sensor .
   DONE : detele the crystal oscillator.
  REV4:
   done: add 5V chip to power the lamp.
    tbd : move the captiance to side to make it fix case of Co2 node.
   tbd : move the direction of Co2 part to make it compatiable with the sensor we buy.
   tbd : move the connection port position.
   Done: add the thermistor to the pic chip.
  REV5:
   DONE: add copper pour to the board. Connect copper pour to GND. DONE: Change the power line for the Lamp to wider.
   DONE: Connect the screw hole to the GND DONE: modify PIC16F1509-20QFN footprint
 REV6:
   DONE . ADD HIM Senor
   DONE : ADD Connector for PM25 Sensor
  DONE : ADD AQ Sensor.
REV7:
 DONE: Convert the TCA9406 prot A and Prot B. ProtB connect to 5V and Prot A connect to 3.3V. Enable pin connect 5v
  DONE : Connect the adc pin to prot1 of the chip .
BEV8 ·
 done:move the humdity sensor and pressure sensor far away from ag sensor
 done:add the i2c wires to the connector
  done: Aq 传感器会项到 TSTAT CO2 PCB板上。 把U6移到背面。 把C21, C20 和AQ 向 C18靠拢。
  done: 把连接传感器 和灯 的焊盘 延长到最边沿, 便于焊接。
  done: 腔体的定位孔 位置需要调整。
  done:把底板上传感器和灯 两端的开槽 宽度加大1mm, 长度加2mm。以便于安装。
  done:由于传感器端的pcb板 顶到腔体, 上下腔体中间有缝隙。 建议把传感器端的PCB 顶部裁剪1mm。
  done:灯那端 PCB板需要覆铜, 防止漏光。
  done:把humdity sensor 移到PCB 另一端。
REV9:
 Done: Separate the digital 5V and analog 5V.
 Done: delete opa2376 , add LMP91051MME
 TBD: Fix 2N7000 ,SI2306,TL431 SCH symbol .
REV10:
 TBD: Fix DTS2306,2N7000 SCH symbol .
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